

74AHC164; 74AHCT164

8-bit serial-in/parallel-out shift register

Rev. 02 — 29 November 2006

Product data sheet

1. General description

The 74AHC164; 74AHCT164 shift register is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7A.

The 74AHC164; 74AHCT164 input signals are 8-bit serial through one of two inputs (DSA or DSB); either input can be used as an active HIGH enable for data entry through the other input. Both inputs must be connected together or an unused input must be tied HIGH.

Data shifts one place to the right on each LOW-to-HIGH transition of the clock input (CP) and enters into output Q0, which is a logical AND of the two data inputs (DSA and DSB) that existed one set-up time prior to the rising clock edge.

A LOW-level on the master reset (\overline{MR}) input overrides all other inputs and clears the register asynchronously, forcing all outputs LOW.

2. Features

- Balanced propagation delays
- All inputs have Schmitt-trigger actions
- Inputs accept voltages higher than V_{CC}
- Input levels:
 - ◆ CMOS levels: 74AHC164 only
 - ◆ TTL levels: 74AHCT164 only
- ESD protection:
 - ◆ HBM JESD22-A114-D exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101-C exceeds 1000 V
- Specified from -40°C to $+85^{\circ}\text{C}$ and from -40°C to $+125^{\circ}\text{C}$

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|------------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | Version |
| 74AHC164 | | | | |
| 74AHC164D | −40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74AHC164PW | −40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74AHC164BQ | −40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |
| 74AHCT164 | | | | |
| 74AHCT164D | −40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74AHCT164PW | −40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74AHCT164BQ | −40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |

4. Functional diagram

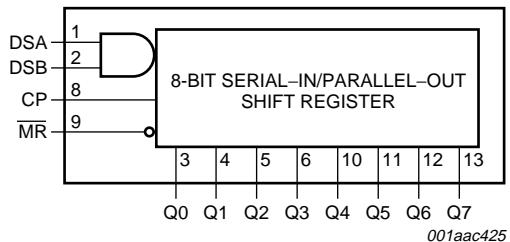


Fig 1. Functional diagram

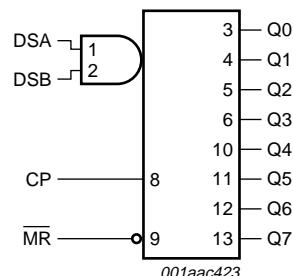


Fig 2. Logic symbol

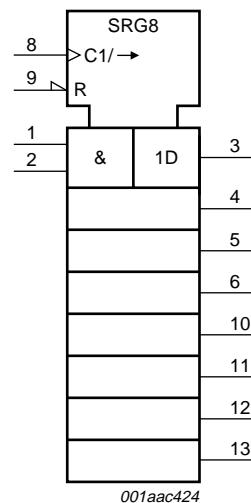


Fig 3. IEC logic symbol

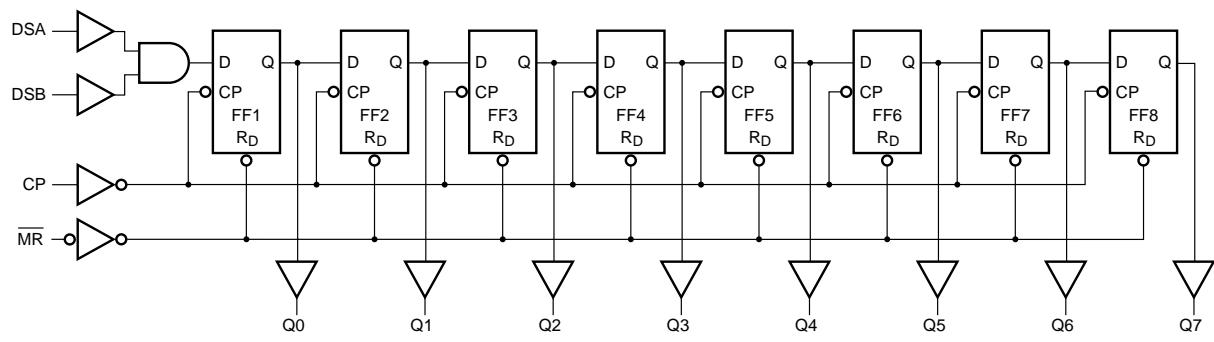
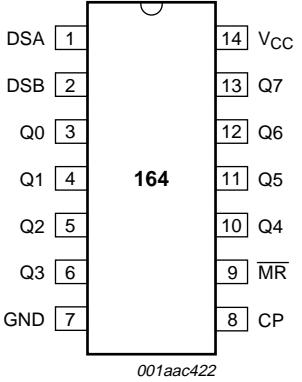
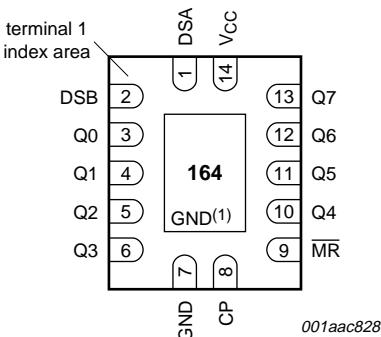


Fig 4. Logic diagram

5. Pinning information

5.1 Pinning

| | |
|--|--|
|  <p>Fig 5. Pin configuration SO14 and TSSOP4</p> |  <p>Fig 6. Pin configuration DHVQFN14</p> <p>(1) The die substrate is attached to this pad using conductive die attach material. It can not be used as a supply pin or input.</p> |
|--|--|

5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|-----|--|
| DSA | 1 | serial data input A |
| DSB | 2 | serial data input B |
| Q0 | 3 | output 0 |
| Q1 | 4 | output 1 |
| Q2 | 5 | output 2 |
| Q3 | 6 | output 3 |
| GND | 7 | ground (0 V) |
| CP | 8 | clock input (LOW-to-HIGH edge-triggered) |
| MR | 9 | master reset input (active LOW) |
| Q4 | 10 | output 4 |
| Q5 | 11 | output 5 |
| Q6 | 12 | output 6 |
| Q7 | 13 | output 7 |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function table^[1]

| Operating mode | Control | | Inputs | | Output | |
|----------------|---------|----|--------|-----|--------|----------|
| | MR | CP | DSA | DSB | Q0 | Q1 to Q7 |
| Reset (clear) | L | X | X | X | L | L to L |
| Shift | H | ↑ | I | I | L | q0 to q6 |
| | H | ↑ | I | h | L | q0 to q6 |
| | H | ↑ | h | I | L | q0 to q6 |
| | H | ↑ | h | h | H | q0 to q6 |

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

↑ = LOW-to-HIGH transition;

X = don't care;

q = lower case letter indicates the state of the referenced input one set-up time prior to the LOW-to-HIGH transition.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|-------|------|------|
| V _{CC} | supply voltage | | -0.5 | +7.0 | V |
| V _I | input voltage | | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | V _I < -0.5 V | [1] - | -20 | mA |
| I _{OK} | output clamping current | V _O < -0.5 V or V _O > V _{CC} + 0.5 V | [1] - | ±20 | mA |
| I _O | output current | V _O = -0.5 V to (V _{CC} + 0.5 V) | - | ±25 | mA |
| I _{CC} | supply current | | - | 75 | mA |
| I _{GND} | ground current | | - | -75 | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | T _{amb} = -40 °C to +125 °C | [2] - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO14 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.

For TSSOP14 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

For DHVQFN14 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|-------------------------------------|----------------------------------|-----|-----|-----------------|------|
| 74AHC164 | | | | | | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | V |
| V _I | input voltage | | 0 | - | 5.5 | V |
| V _O | output voltage | | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 3.0 V to 3.6 V | - | - | 100 | ns/V |
| | | V _{CC} = 4.5 V to 5.5 V | - | - | 20 | ns/V |
| 74AHCT164 | | | | | | |
| V _{CC} | supply voltage | | 4.5 | 5.0 | 5.5 | V |
| V _I | input voltage | | 0 | - | 5.5 | V |
| V _O | output voltage | | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 4.5 V to 5.5 V | - | - | 20 | ns/V |

9. Static characteristics

Table 6. Static characteristics 74AHC164

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|---------------------------|--|------|-----|------|------|
| T_{amb} = 25 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | - | - | V |
| | | V _{CC} = 3.0 V | 2.1 | - | - | V |
| | | V _{CC} = 5.5 V | 3.85 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.5 | V |
| | | V _{CC} = 3.0 V | - | - | 0.9 | V |
| | | V _{CC} = 5.5 V | - | - | 1.65 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -50 μA; V _{CC} = 2.0 V | 1.9 | 2.0 | - | V |
| | | I _O = -50 μA; V _{CC} = 3.0 V | 2.9 | 3.0 | - | V |
| | | I _O = -50 μA; V _{CC} = 4.5 V | 4.4 | 4.5 | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.58 | - | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.94 | - | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 50 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 3.0 V | - | 0 | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.36 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.36 | V |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | 0.1 | μA |

Table 6. Static characteristics 74AHC164 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---------------------------|---|------|-----|------|------|
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 4.0 | µA |
| C _I | input capacitance | | - | 3 | 10 | pF |
| T_{amb} = -40 °C to +85 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | - | - | V |
| | | V _{CC} = 3.0 V | 2.1 | - | - | V |
| | | V _{CC} = 5.5 V | 3.85 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.5 | V |
| | | V _{CC} = 3.0 V | - | - | 0.9 | V |
| | | V _{CC} = 5.5 V | - | - | 1.65 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -50 µA; V _{CC} = 2.0 V | 1.9 | - | - | V |
| | | I _O = -50 µA; V _{CC} = 3.0 V | 2.9 | - | - | V |
| | | I _O = -50 µA; V _{CC} = 4.5 V | 4.4 | - | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.48 | - | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.8 | - | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 50 µA; V _{CC} = 2.0 V | - | - | 0.1 | V |
| | | I _O = 50 µA; V _{CC} = 3.0 V | - | - | 0.1 | V |
| | | I _O = 50 µA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 4 mA; V _{CC} = 3.0 V | - | - | 0.44 | V |
| | | I _O = 8 mA; V _{CC} = 4.5 V | - | - | 0.44 | V |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | 1.0 | µA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 40 | µA |
| T_{amb} = -40 °C to +125 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | - | - | V |
| | | V _{CC} = 3.0 V | 2.1 | - | - | V |
| | | V _{CC} = 5.5 V | 3.85 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.5 | V |
| | | V _{CC} = 3.0 V | - | - | 0.9 | V |
| | | V _{CC} = 5.5 V | - | - | 1.65 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -50 µA; V _{CC} = 2.0 V | 1.9 | - | - | V |
| | | I _O = -50 µA; V _{CC} = 3.0 V | 2.9 | - | - | V |
| | | I _O = -50 µA; V _{CC} = 4.5 V | 4.4 | - | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.40 | - | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.70 | - | - | V |

Table 6. Static characteristics 74AHC164 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------------|--------------------------|---|-----|-----|------|------|
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 50 µA; V _{CC} = 2.0 V | - | - | 0.1 | V |
| | | I _O = 50 µA; V _{CC} = 3.0 V | - | - | 0.1 | V |
| | | I _O = 50 µA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 4 mA; V _{CC} = 3.0 V | - | - | 0.55 | V |
| | | I _O = 8 mA; V _{CC} = 4.5 V | - | - | 0.55 | V |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | 2.0 | µA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 80 | µA |

Table 7. Static characteristics 74AHCT164

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---------------------------|---|------|-----|------|------|
| T_{amb} = 25 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -50 µA; V _{CC} = 4.5 V | 4.4 | 4.5 | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.94 | - | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 50 µA; V _{CC} = 4.5 V | - | 0 | 0.1 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.36 | V |
| I _I | input leakage current | V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V | - | - | 0.1 | µA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 4.0 | µA |
| ΔI _{CC} | additional supply current | per input pin; V _I = V _{CC} - 2.1 V; other inputs at V _{CC} or GND; I _O = 0 A; V _{CC} = 4.5 V to 5.5 V | - | - | 1.35 | mA |
| C _I | input capacitance | | - | 3 | 10 | pF |
| T_{amb} = -40 °C to +85 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -50 µA; V _{CC} = 4.5 V | 4.4 | - | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.8 | - | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 50 µA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.44 | V |
| I _I | input leakage current | V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V | - | - | 1.0 | µA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 40 | µA |

Table 7. Static characteristics 74AHCT164 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---------------------------|---|-------------|-----|-------------|------|
| ΔI_{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1$ V; other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V | - | - | 1.5 | mA |
| $T_{amb} = -40$ °C to +125 °C | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 4.5$ V to 5.5 V | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 4.5$ V to 5.5 V | - | - | 0.8 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} $I_O = -50$ µA; $V_{CC} = 4.5$ V $I_O = -8.0$ mA; $V_{CC} = 4.5$ V | 4.4 3.70 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} $I_O = 50$ µA; $V_{CC} = 4.5$ V $I_O = 8.0$ mA; $V_{CC} = 4.5$ V | - - | - | 0.1 0.55 | V |
| I_I | input leakage current | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V | - | - | 2.0 | µA |
| I_{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V | - | - | 80 | µA |
| ΔI_{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1$ V; other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V | - | - | 1.5 | mA |

10. Dynamic characteristics

Table 8. Dynamic characteristics 74AHC164

Voltages are referenced to GND (ground = 0 V); for the test circuit see [Figure 10](#).

| Symbol | Parameter | Conditions | 25 °C | | | −40 °C to +125 °C | | | | Unit |
|------------------------------|-------------------------------|--|-------|--------------------|------|-------------------|----------------|-----------------|-----------------|------|
| | | | Min | Typ ^[1] | Max | Min (85 °C) | Max (85 °C) | Min (125 °C) | Max (125 °C) | |
| C_L = 15 pF | | | | | | | | | | |
| t _{PHL} | HIGH-to-LOW propagation delay | CP to Qn; see Figure 7 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | - | 6.5 | 12.8 | 1.0 | 15.0 | 1.0 | 16.0 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | - | 4.5 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | | MR to Qn; see Figure 8 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | - | 5.3 | 12.8 | 1.0 | 15.0 | 1.0 | 16.0 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | - | 4.0 | 8.6 | 1.0 | 10.0 | 1.0 | 11.0 | ns |
| t _{PLH} | LOW-to-HIGH propagation delay | CP to Qn; see Figure 7 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | - | 6.5 | 12.8 | 1.0 | 15.0 | 1.0 | 16.0 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | - | 4.5 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| f _{max} | maximum frequency | see Figure 7 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | 80 | 125 | - | 65 | - | 50 | - | MHz |
| | | V _{CC} = 4.5 V to 5.5 V | 125 | 175 | - | 105 | - | 85 | - | MHz |
| C_L = 50 pF | | | | | | | | | | |
| t _{PHL} | HIGH-to-LOW propagation delay | CP to Qn; see Figure 7 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | - | 9.3 | 16.3 | 1.0 | 18.5 | 1.0 | 20.5 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | - | 6.4 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns |
| | | MR to Qn; see Figure 8 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | - | 7.6 | 16.3 | 1.0 | 18.5 | 1.0 | 20.5 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | - | 5.8 | 10.6 | 1.0 | 12.0 | 1.0 | 13.5 | ns |
| t _{PLH} | LOW-to-HIGH propagation delay | CP to Qn; see Figure 7 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | - | 9.3 | 16.3 | 1.0 | 18.5 | 1.0 | 20.5 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | - | 6.4 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns |
| t _w | pulse width | CP HIGH or LOW; see Figure 7 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | V _{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{WL} | pulse width LOW | MR; see Figure 8 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | V _{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{su} | set-up time | DSA, DSB to CP; see Figure 9 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | 5.0 | - | - | 6.0 | - | 6.0 | - | ns |
| | | V _{CC} = 4.5 V to 5.5 V | 4.5 | - | - | 4.5 | - | 4.5 | - | ns |

Table 8. Dynamic characteristics 74AHC164 ...continuedVoltages are referenced to GND (ground = 0 V); for the test circuit see [Figure 10](#).

| Symbol | Parameter | Conditions | 25 °C | | | −40 °C to +125 °C | | | | Unit |
|------------------|-------------------------------|---|-------|--------------------|-----|-------------------|----------------|-----------------|-----------------|------|
| | | | Min | Typ ^[1] | Max | Min (85 °C) | Max (85 °C) | Min (125 °C) | Max (125 °C) | |
| t _h | hold time | DSA, DSB to CP; see Figure 9 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | - | - | 1.5 | - | 1.5 | - | ns |
| | | V _{CC} = 4.5 V to 5.5 V | 2.0 | - | - | 2.0 | - | 2.0 | - | ns |
| t _{rec} | recovery time | MR to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | 2.5 | - | - | 2.5 | - | 2.5 | - | ns |
| | | V _{CC} = 4.5 V to 5.5 V | 2.5 | - | - | 2.5 | - | 2.5 | - | ns |
| f _{max} | maximum frequency | see Figure 7 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | 50 | 75 | - | 45 | - | 35 | - | MHz |
| | | V _{CC} = 4.5 V to 5.5 V | 85 | 115 | - | 75 | - | 65 | - | MHz |
| C _{PD} | power dissipation capacitance | f _i = 1 MHz; V _i = GND to V _{cc} | [2] | - | 48 | - | - | - | - | pF |

[1] All typical values are measured at nominal V_{CC}.[2] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;f_o = output frequency in MHz;C_L = output load capacitance in pF;V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.**Table 9. Dynamic characteristics 74AHCT164**Voltages are referenced to GND (ground = 0 V); for the test circuit see [Figure 10](#).

| Symbol | Parameter | Conditions | 25 °C | | | −40 °C to +125 °C | | | | Unit |
|---|-------------------------------|--|-------|--------------------|------|-------------------|----------------|-----------------|-----------------|------|
| | | | Min | Typ ^[1] | Max | Min (85 °C) | Max (85 °C) | Min (125 °C) | Max (125 °C) | |
| C_L = 15 pF; V_{CC} = 4.5 V to 5.5 V | | | | | | | | | | |
| t _{PHL} | HIGH-to-LOW propagation delay | CP to Qn; see Figure 7 | - | 3.4 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | | MR to Qn; see Figure 8 | - | 3.5 | 8.6 | 1.0 | 10.0 | 1.0 | 11.0 | ns |
| t _{PLH} | LOW-to-HIGH propagation delay | CP to Qn; see Figure 7 | - | 3.4 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| f _{max} | maximum frequency | see Figure 8 | 125 | 175 | - | 105 | - | 85 | - | MHz |
| C_L = 50 pF; V_{CC} = 4.5 V to 5.5 V | | | | | | | | | | |
| t _{PHL} | HIGH-to-LOW propagation delay | CP to Qn; see Figure 7 | - | 4.9 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns |
| | | MR to Qn; see Figure 8 | - | 5.0 | 10.6 | 1.0 | 12.0 | 1.0 | 13.5 | ns |

Table 9. Dynamic characteristics 74AHCT164 ...continuedVoltages are referenced to GND (ground = 0 V); for the test circuit see [Figure 10](#).

| Symbol | Parameter | Conditions | 25 °C | | | −40 °C to +125 °C | | | | Unit |
|------------------|-------------------------------|---|-------|--------------------|------|-------------------|----------------|-----------------|-----------------|------|
| | | | Min | Typ ^[1] | Max | Min (85 °C) | Max (85 °C) | Min (125 °C) | Max (125 °C) | |
| t _{PLH} | LOW-to-HIGH propagation delay | CP to Qn; see Figure 7 | - | 4.9 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns |
| t _w | pulse width | CP HIGH or LOW; see Figure 7 | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{WL} | pulse width LOW | MR; see Figure 8 | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{su} | set-up time | DSA, DSB to CP; see Figure 9 | 4.5 | - | - | 4.5 | - | 4.5 | - | ns |
| t _h | hold time | DSA, DSB to CP; see Figure 9 | 2.0 | - | - | 2.0 | - | 2.0 | - | ns |
| t _{rec} | recovery time | MR to CP; see Figure 8 | 2.5 | - | - | 2.5 | - | 2.5 | - | ns |
| f _{max} | maximum frequency | see Figure 7 | 85 | 115 | - | 75 | - | 65 | - | MHz |
| C _{PD} | power dissipation capacitance | f _i = 1 MHz; V _i = GND to V _{cc} | [2] | - | 51 | - | - | - | - | pF |

[1] All typical values are measured at V_{CC} = 5.0 V.[2] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

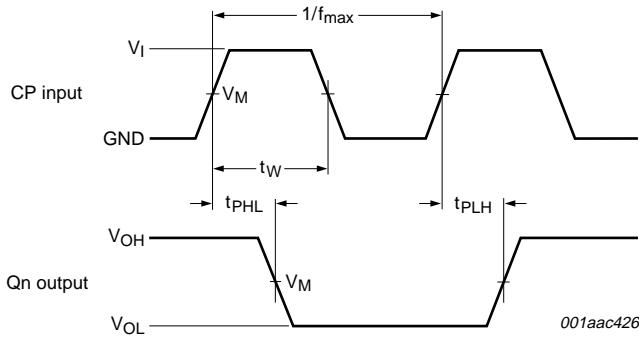
$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;f_o = output frequency in MHz;C_L = output load capacitance in pF;V_{CC} = supply voltage in V;

N = number of inputs switching;

$$\sum(C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs.}$$

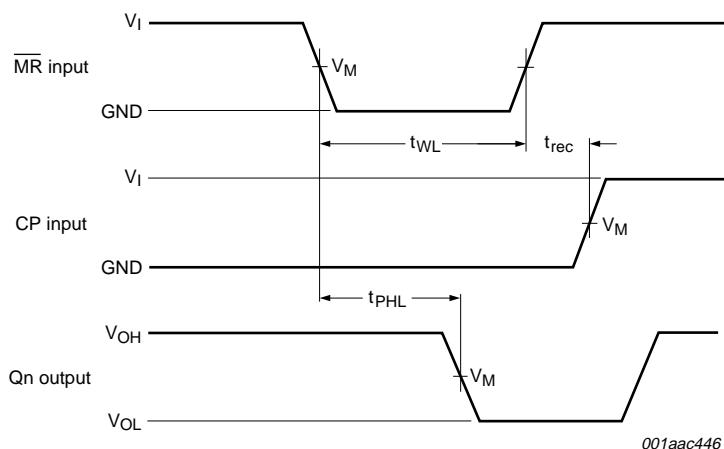
11. Waveforms



Measurement points are given in [Table 10](#).

V_{OL} and V_{OH} are typical voltage output drop that occur with the output load.

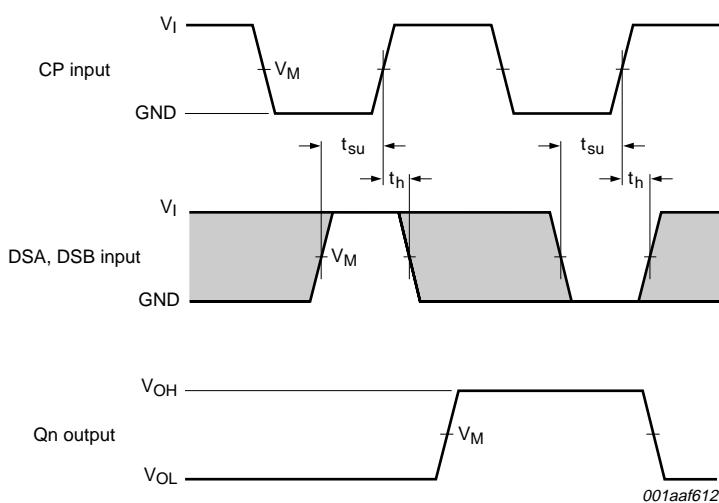
Fig 7. The clock (CP) to output (Qn) propagation delays, the clock (CP) pulse width and the maximum clock (CP) frequency



Measurement points are given in [Table 10](#).

V_{OL} and V_{OH} are typical voltage output drop that occur with the output load.

Fig 8. The master reset (MR) pulse width, the master reset (MR) to output (Qn) propagation delays and the master reset (MR) to clock (CP) recovery time



Measurement points are given in [Table 10](#).

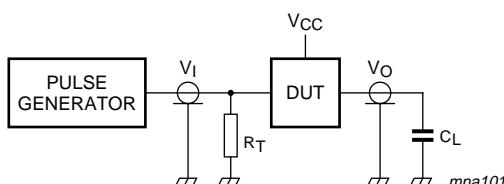
The shaded areas indicate when the input is permitted to change for predictable output performance.

V_{OL} and V_{OH} are typical voltage output drop that occur with the output load.

Fig 9. The data set-up and hold times for the (DSA and DSB) inputs

Table 10. Measurement points

| Type | Input | Output |
|-----------|---------------------|---------------------|
| | V_M | V_M |
| 74AHC164 | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 74AHCT164 | 1.5 V | $0.5 \times V_{CC}$ |



Test data is given in [Table 11](#).

Definitions test circuit:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator

C_L = Load capacitance including jig and probe capacitance

Fig 10. Load circuitry for measuring switching times

Table 11. Test data

| Type | Input | | Load | Test |
|-----------|----------|---------------|--------------|--------------------|
| | V_I | t_r, t_f | | |
| 74AHC164 | V_{CC} | ≤ 3.0 ns | 50 pF, 15 pF | t_{PLH}, t_{PHL} |
| 74AHCT164 | 3.0 V | ≤ 3.0 ns | 50 pF, 15 pF | t_{PLH}, t_{PHL} |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

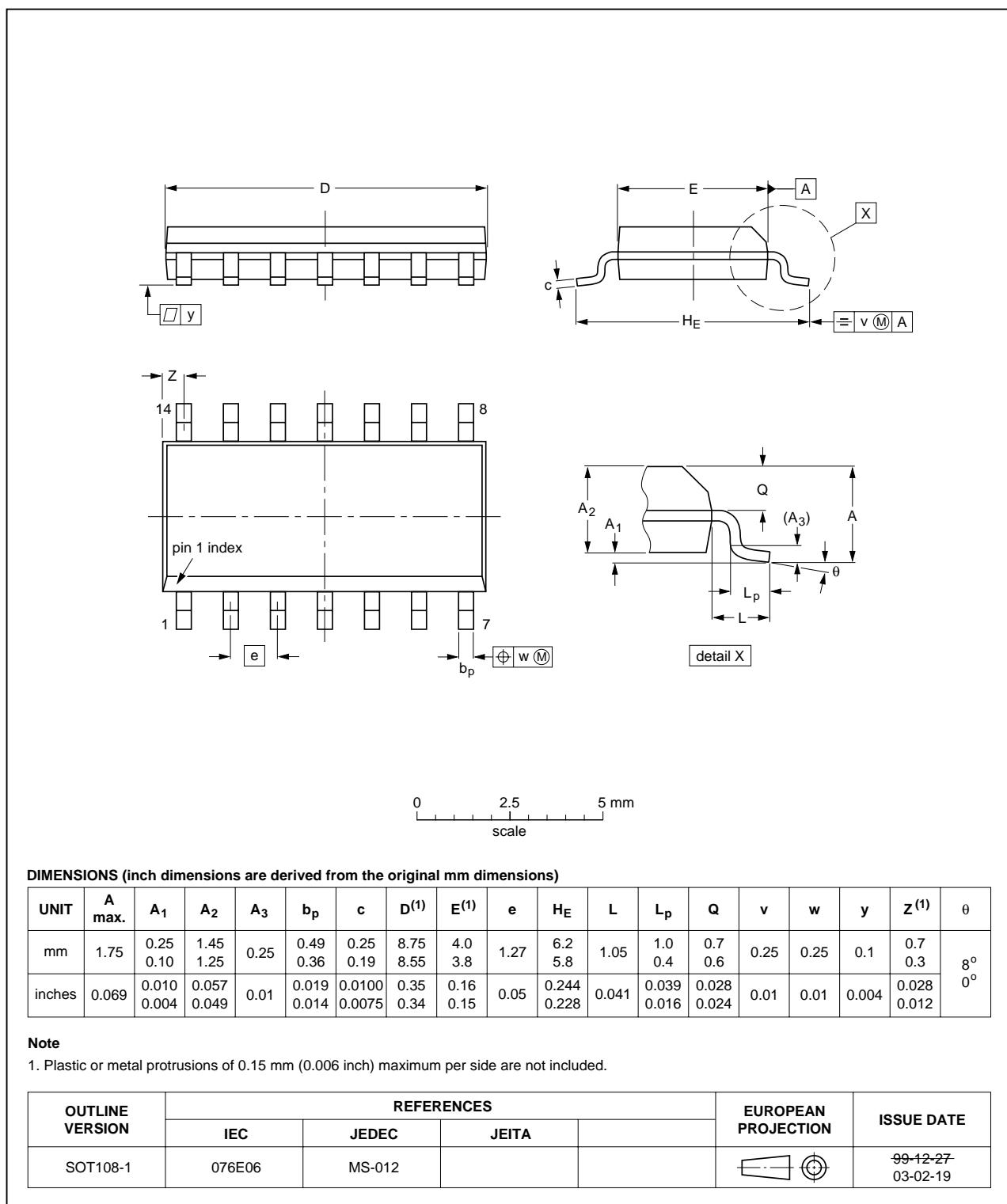


Fig 11. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

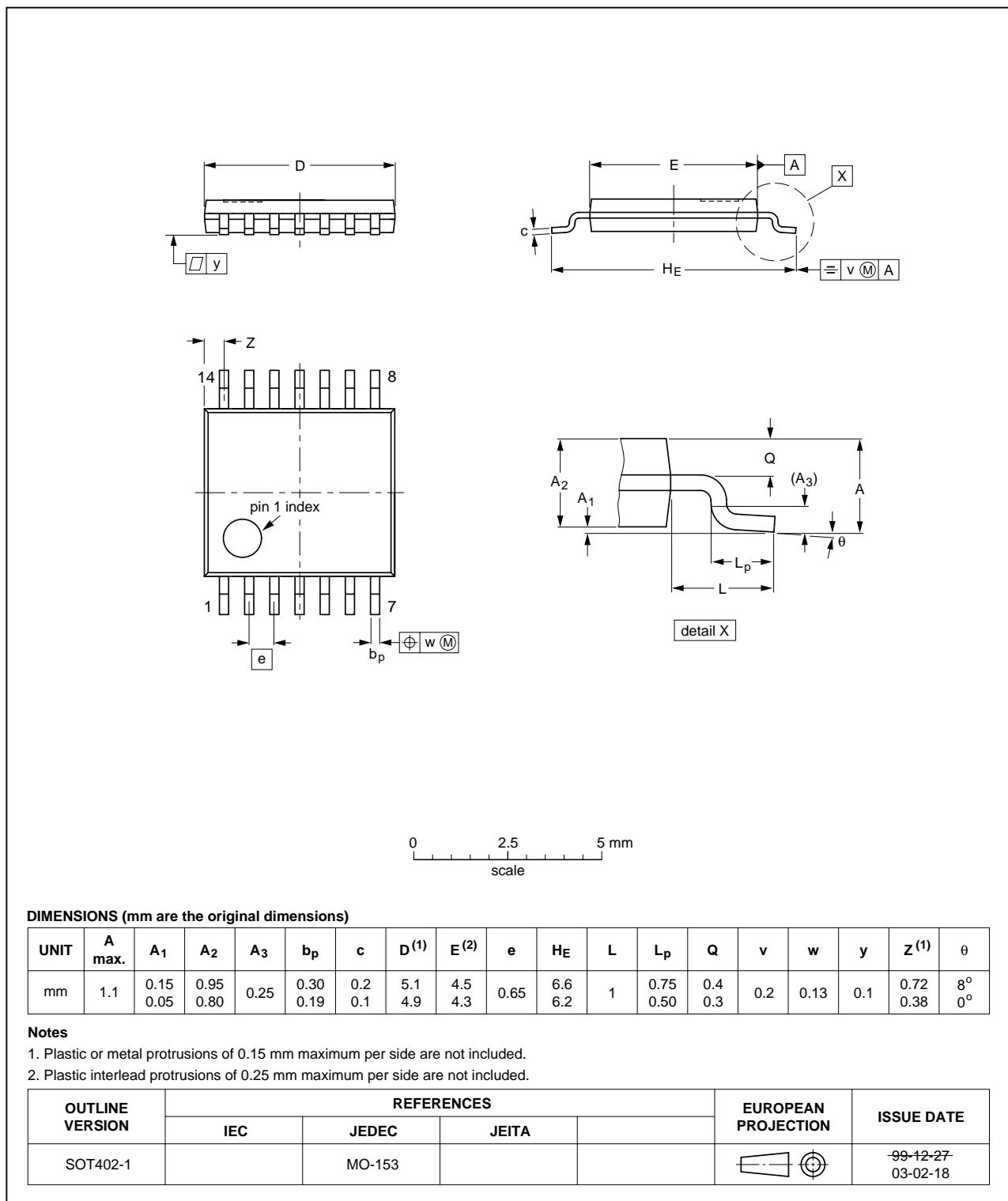


Fig 12. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;
14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

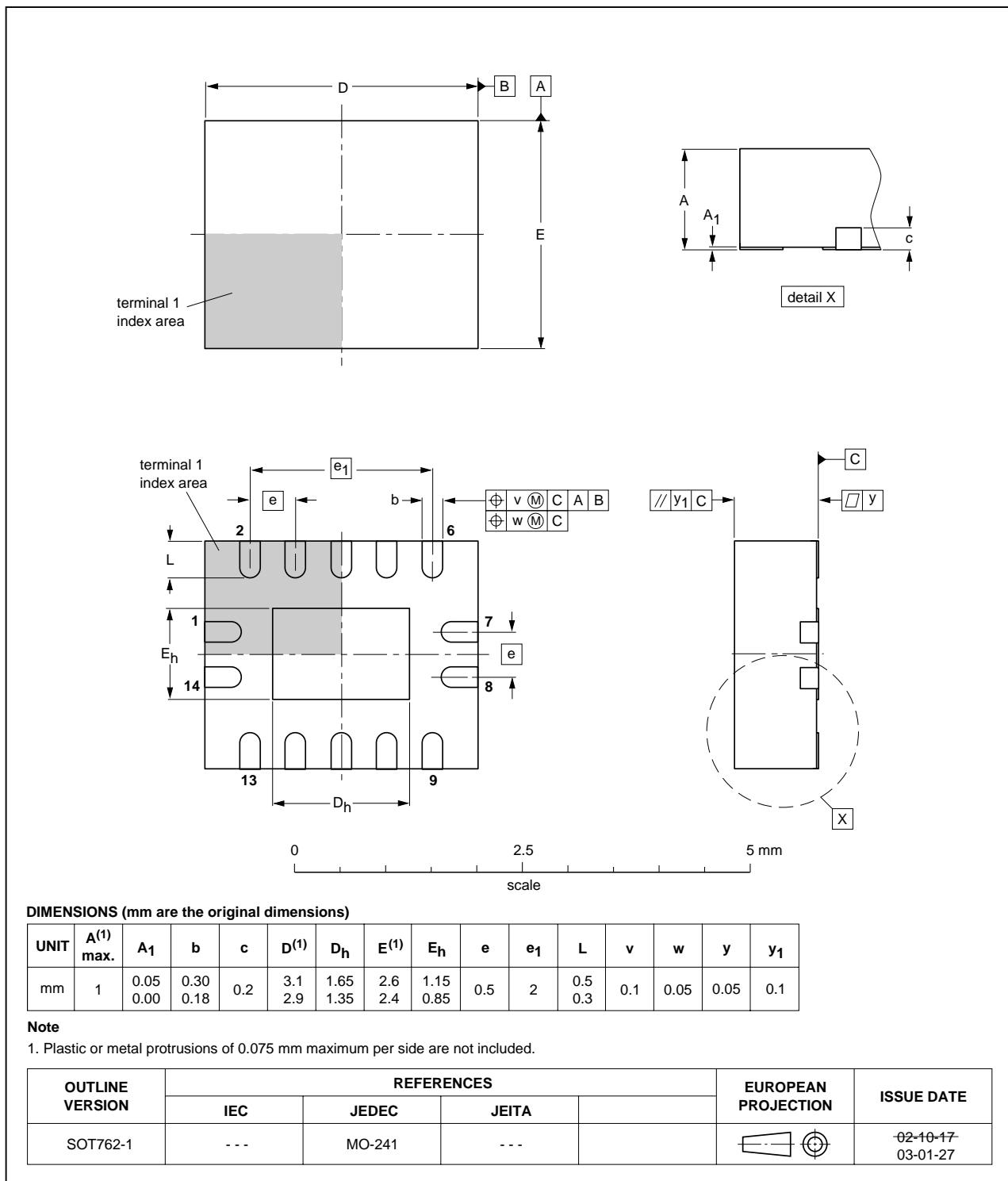


Fig 13. Package outline SOT762-1 (DHVQFN14)

13. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------------------------|--------------|--|---------------|-----------------|
| 74AHC_AHCT164_2 | 20061129 | Product data sheet | - | 74AHC_AHCT164_1 |
| Modifications: | | <ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.Legal texts have been adapted to the new company name where appropriate.The dynamic characteristics table has been reformatted.Type numbers 74AHC164BQ and 74AHCT164BQ (package DHVQFN14) have been added. | | |
| 74AHC_AHCT164_1 (9397 750 07332) | 20000815 | Product specification | - | - |

14. Legal information

14.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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